



30V N-Channel MOSFETs

General Description

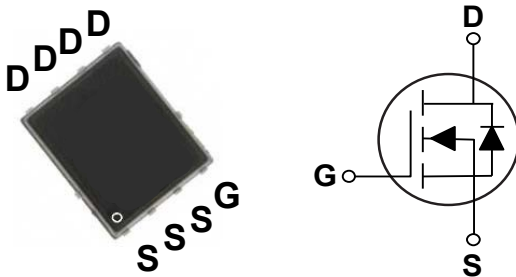
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BV_{DSS}	$R_{DS(ON)}$	I_D
30V	8.5 mΩ	60 A

Features

- $R_{DS(ON)} \leq 8.5m\Omega @ V_{GS}=10V$
- Improved dv/dt capability
- Fast switching
- Green Device Available

PPAK5X6 Pin Configuration



Applications

- MB / VGA / Vcore
- POL Applications
- SMPS 2nd SR

Absolute Maximum Ratings $T_C=25^\circ C$ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	30	V
V_{GS}	Gate-Source Voltage	±20	V
I_D	Drain Current - Continuous ($T_C=25^\circ C$)	60	A
	Drain Current - Continuous ($T_C=100^\circ C$)	38	A
I_{DM}	Drain Current - Pulsed (NOTE 1)	240	A
EAS	Single Pulse Avalanche Energy (NOTE 2)	31	mJ
IAS	Single Pulse Avalanche Current (NOTE 2)	25	A
P_D	Power Dissipation ($T_C=25^\circ C$)	54	W
	Power Dissipation - Derate above 25°C	0.43	W/°C
T_J	Operating Junction Temperature Range	-50 to 150	°C
T_{STG}	Storage Temperature Range	-50 to 150	°C
Marking Code		NC8P5	

Thermal Characteristics

Symbol	Parameter	Typ.	Max	Unit
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	---	62	°C/W
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	2.3	°C/W

**Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)****Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	30	---	---	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=24V, V_{GS}=0V, T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{DS}=24V, V_{GS}=0V, T_J=125^\circ\text{C}$	---	---	10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	± 100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$R_{DS(ON)}$	Static Drain-Source On-Resistance (NOTE 3)	$V_{GS}=10V, I_D=15A$	---	---	8.5	m Ω
		$V_{GS}=4.5V, I_D=8A$	---	---	11	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	1.2	1.6	2.5	V
gfs	Forward Transconductance	$V_{DS}=10V, I_D=8A$	---	5.6	---	S

Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
Q_g	Total Gate Charge	$V_{DS}=15V, V_{GS}=10V, I_D=1A$	---	23.2	---	nC
Q_{gs}	Gate-Source Charge		---	3.2	---	
Q_{gd}	Gate-Drain Charge		---	3.7	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=10V, V_{GS}=10V, R_{GEN}=2.7\Omega, I_D=30A$	---	7	---	nS
T_r	Rise Time		---	76.6	---	
$T_{d(off)}$	Turn-Off Delay Time		---	27.1	---	
T_f	Fall Time		---	52.6	---	
C_{iss}	Input Capacitance	$V_{DS}=15V, V_{GS}=0V, F=1\text{MHz}$	---	1180	---	pF
C_{oss}	Output Capacitance		---	177	---	
C_{rss}	Reverse Transfer Capacitance		---	132	---	
R_g	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$	---	3.2	---	Ω

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current	$V_G=V_D=0V$, Force Current	---	---	60	A
I_{SM}	Pulsed Source Current		---	---	240	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_S=1A, T_J=25^\circ\text{C}$	---	---	1	V

NOTES :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. $V_{DD}=25V, V_{GS}=10V, L=0.1\text{mH}, I_{AS}=25A, R_G=25\Omega$, Starting $T_J=25^\circ\text{C}$.
3. The data tested by pulsed, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
4. Essentially independent of operating temperature.



Characteristics Curves

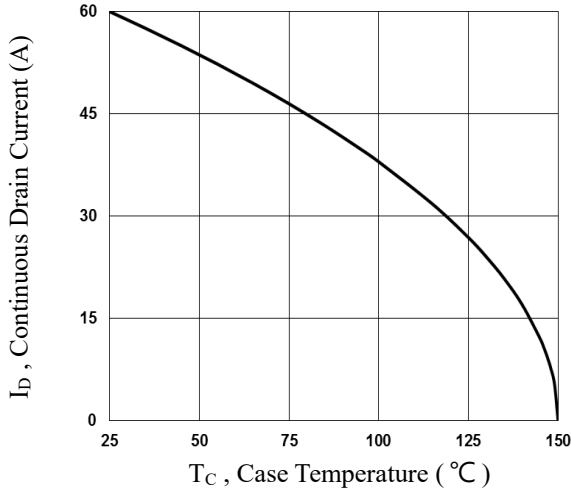


Fig.1 Continuous Drain Current vs. T_C

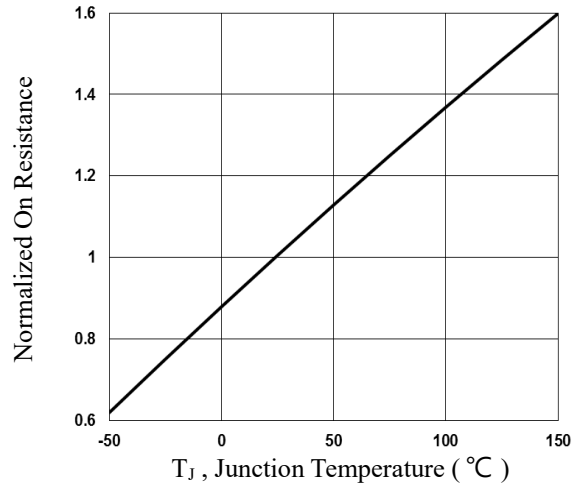


Fig.2 Normalized $R_{DS(on)}$ vs. T_J

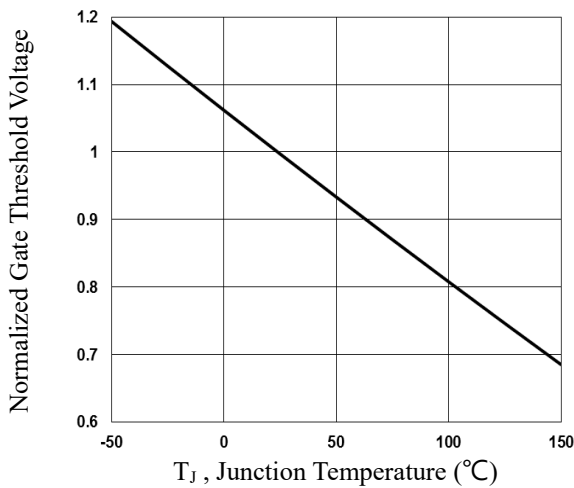


Fig.3 Normalized V_{th} vs. T_J

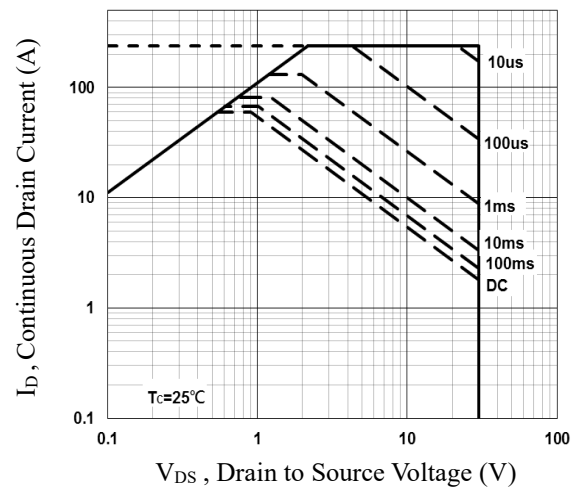


Fig.4 Maximum Safe Operation Area

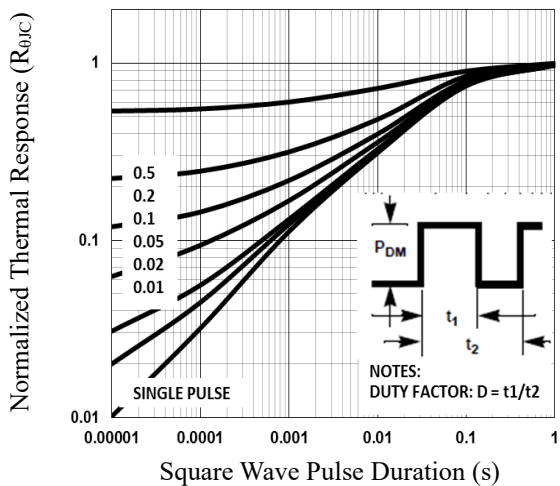


Fig.5 Normalized Transient Impedance

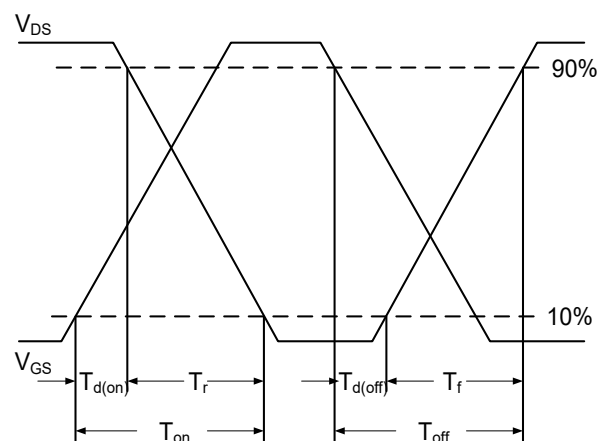


Fig.6 Switching Time Waveform



Characteristics Curves

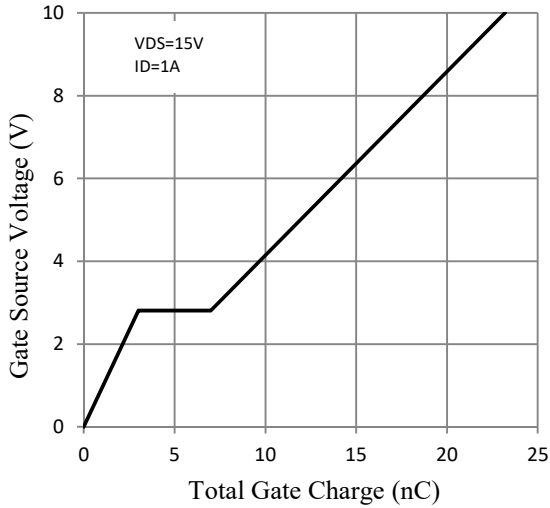
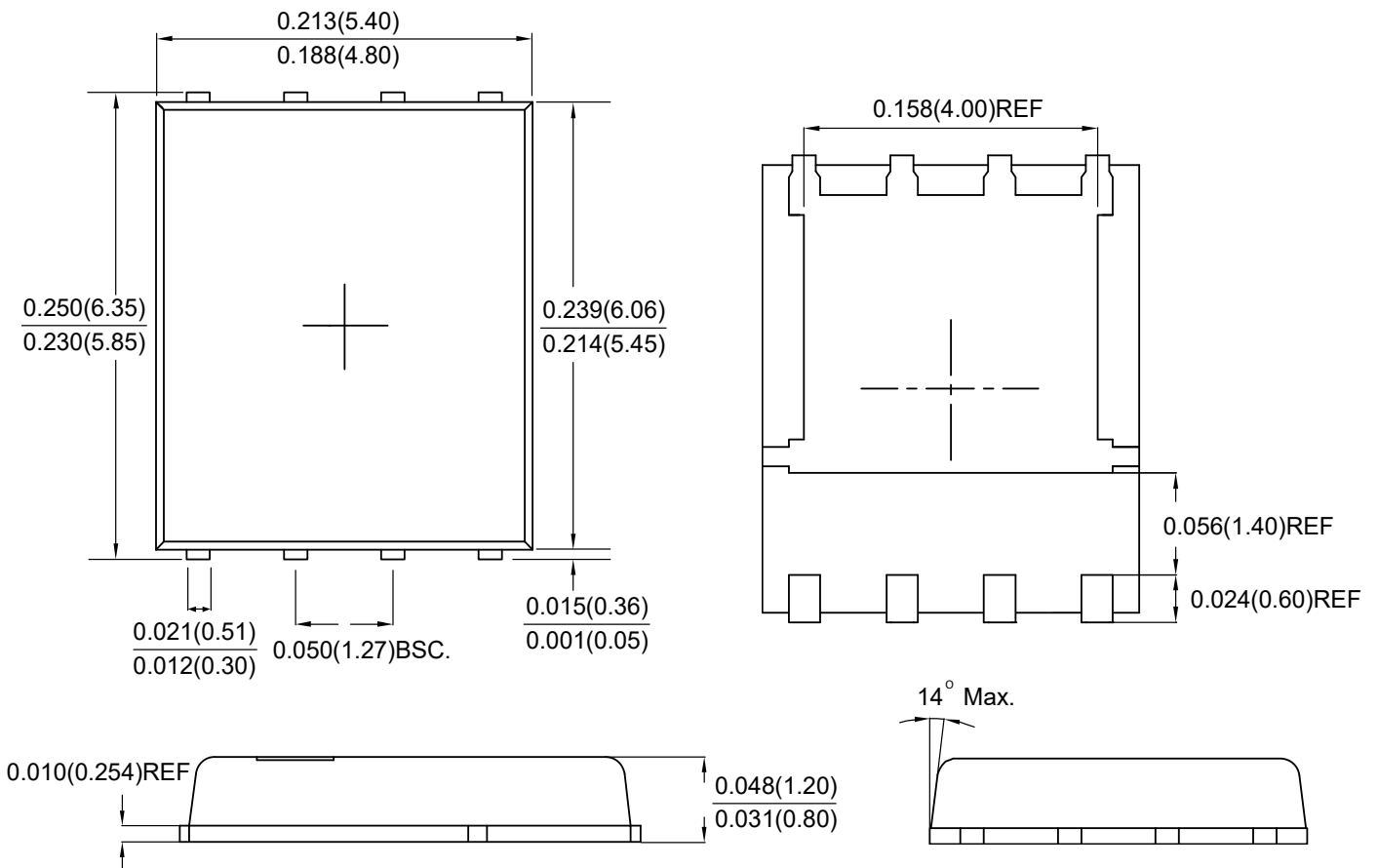


FIG. 7 Gate Charge Characteristics

Package Outline Dimensions



PPAK5X6

Dimensions in inches and (millimeters)



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